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**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant: Michael Bauer et al.

**IAP20 Rec'd PCT/PTO 19 JAN 2006**

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(Priority Application No. 10 2004 025 279.3)  
(International Application No. PCT/DE2005/000892)

Filed: Herewith  
(Priority Date 19 May 2004)  
(International Filing Date 17 May 2005)

Docket No.: I431.145.101/FIN 606 PCT

Title: SUPPORT WITH SOLDER BALL ELEMENTS AND A METHOD FOR  
POPULATING SUBSTRATES WITH SOLDER BALLS

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**PRELIMINARY AMENDMENT**

Mail Stop PCT  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

This Preliminary Amendment amends the Utility Patent Application filed herewith and should be used to calculate filing fees due. Prior to examination of the above-identified patent application, please amend as follows: